THERM-A-GAP™ GEL45

High Performance Fully Cured Dispensable GEL



Product Family Description

Parker Chomerics fully cured dispensable GELs eliminate time consuming hand assembly, decreasing installation costs and reducing customer manufacturing and purchasing (logistical)complexity. These roducts require no mixing or curing, providing superior design fl exibility.

- Provides low thermal impedance at thin and thick gaps, allowing use of common heat spreaders
- Deflects easily under very low compressive forces, decreasing stress on components thus decreasing component failures.

Typical Applications

- Automotive Electronic Control Units (ECU's)
- Power Supplies & Semiconductors
- Memory & Power Modules
- Microprocessors / Graphics Processors
- Flat Panel Displays & Consumer Electronics

Features/Benefits

- Easily dispensable
- Fully-cured / No pump out
- · High bulk thermal conductivity
- Low thermal impedance
- Ultra low compression force
- High tack surface & reworkable
- · Proven long-term reliability

Product Attributes

- Accommodates a variety of bond line thicknesses for application to multiple devices
- Excellent performance-to-price
- Compatible with high volume, automated dispense processes
- Meets Telcordia (Bellcore) silicone specifications
- High Bulk Thermal Conductivity

| Typical Properties | | GEL 45 | Test Method |
|--------------------|--|----------------------------|-------------------------|
| Physical | Color | Black | Visual |
| | Flow Rate, grams/min - 30cc syringe with no tip attachment 0.100" orifice, 90psi (621 kPa) | 55 | Chomerics |
| | Specific Gravity | 3.1 | ASTM D792 |
| | Typical minimum bondline thickness, in (mm) | 0.0035 (0.0889) | |
| | Thermal Conductivity, W/m-K | 4.5 | ASTM D5470 |
| nal | Heat Capacity, J/g-K | 1 | ASTM E1269 |
| Thermal | Coefficient of Thermal Expansion, ppm/K | 150 | ASTM E831 |
| | Operating Temperature Range, °F (°C) | -67 to 392 (-55 to 200) | |
| Electrical | Dielectric Strength, Vac / mil (KVac/mm) | 200 (8) | ASTM D149 MOD |
| Regulatory | Flammability Rating | V-0 | UL 94 |
| | RoHS Compliant | Yes | Chomerics Certification |
| | Outgassing, % TML (CVCM) | 0.26 (0.06) | ASTM E595 |
| | Shelf Life, months from date of manufacture | 18 | Chomerics |

www.chomerics.com www.parker.com/chomerics

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